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January 2001

FDC640P

FAIRCHILD

P-Channel 2.5V PowerTrench[®] Specified MOSFET

General Description

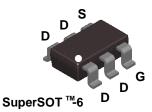
This P-Channel 2.5V specified MOSFET uses a rugged gate version of Fairchild's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

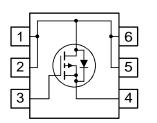
Applications

- Battery management
- Load switch
- Battery protection

Features

- -4.5 A, -20 V $R_{DS(ON)} = 0.053 \ \Omega \ @ V_{GS} = -4.5 \ V$ $R_{DS(ON)} = 0.080 \ \Omega \ @ V_{GS} = -2.5 \ V$
- Rugged gate rating (±12V)
- Fast switching speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±12	V
I _D	Drain Current – Continuous	(Note 1a)	-4.5	A
	– Pulsed		-20	
PD	Maximum Power Dissipation	(Note 1a)	1.6	W
		(Note 1b)	0.8	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
.640	FDC640P	7"	8mm	3000 units
			•	

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FDC640P

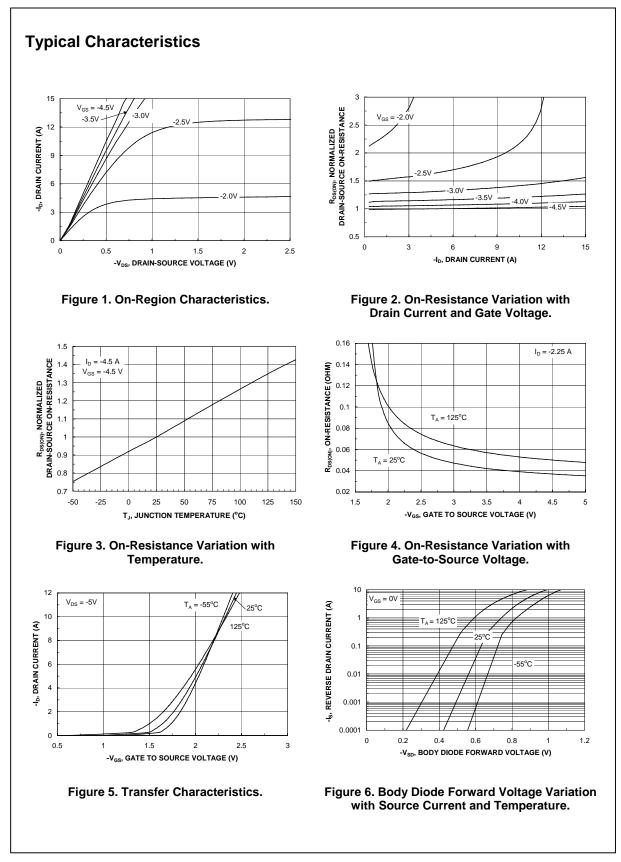
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
- Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-20			V
ΔBV_{DSS} ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-14		mV/°C
	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
I _{GSSF}	Gate–Body Leakage, Forward	$V_{GS} = 12 V$, $V_{DS} = 0 V$			100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -12 V$, $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)				L	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.6	-1.0	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS}=-4.5 \; V, I_{D}=-4.5 \; A \\ V_{GS}=-2.5 \; V, I_{D}=-3.6 \; A \\ V_{GS}=-4.5 \; V, \; I_{D}=-4.5 A, \\ T_{J}=125^{\circ}C \end{array} $		0.039 0.062 0.053	0.053 0.080 0.077	Ω
D(on)	On–State Drain Current	$V_{\text{GS}} = -4.5 \text{ V}, \qquad V_{\text{DS}} = -5 \text{ V}$	-20			Α
g fs	Forward Transconductance	$V_{\text{DS}} = -5 \text{ V}, \qquad I_{\text{D}} = -4.5 \text{ A}$		16		S
Dynamic	c Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		890		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		244		pF
C _{rss}	Reverse Transfer Capacitance			123		pF
Switchir	g Characteristics (Note 2)			•		
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -10 V$, $I_D = -1 A$,		12	22	ns
tr	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		9	18	ns
t _{d(off)}	Turn–Off Delay Time			24	38	ns
t _f	Turn–Off Fall Time			13	23	ns
Qg	Total Gate Charge	$V_{DS} = -10 V$, $I_D = -4.5 A$,		9	13	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		2		nC
Q _{gd}	Gate-Drain Charge			3		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source				-1.3	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -1.3 A$ (Note 2)		-0.7	-1.2	V

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.

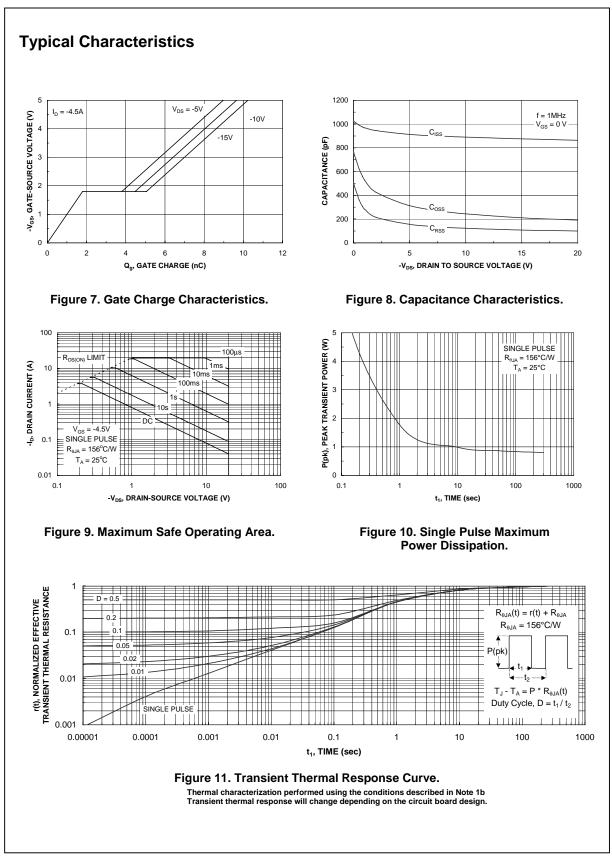
a. 78°C/W when mounted on a 1in² pad of 2oz copper on FR-4 board.

b. 156°C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width $\leq 300~\mu s,$ Duty Cycle $\leq 2.0\%$



FDC640P



FDC640P

FDC640P Rev E(W)

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PowerTrench[®] QFET™ QS™ QT Optoelectronics[™] Quiet Series[™] SILENT SWITCHER® SMART START™ SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-8

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Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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	1	Rev G

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